

C1825C124MCRACTU

Aliases (C1825C124MCRAC7800)

SMD Comm X7R HV, Ceramic, 0.12 uF, 20%, 500 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1825, 2.3 mm



General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	280 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1825
L	4.5mm +/-0.3mm
W	6.4mm +/-0.4mm
Т	1.6mm +/-0.20mm
S	2.3mm MIN
В	0.6mm +/-0.35mm

Т	1.6mm +/-0.20mm	Voltage DC	500 VE
S	2.3mm MIN	Dielectric Withstanding Voltage	750 VE
В	0.6mm +/-0.35mm	Temperature Range	-55/+12
		Temp. Coefficient	X7R
Packaging Specifications		Capacitance Change with	15%, 1kł
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity	1000	Dissipation Factor	2 5% 1 4

Specifications	
Capacitance	0.12 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0 Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	833.3 MOhms

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